



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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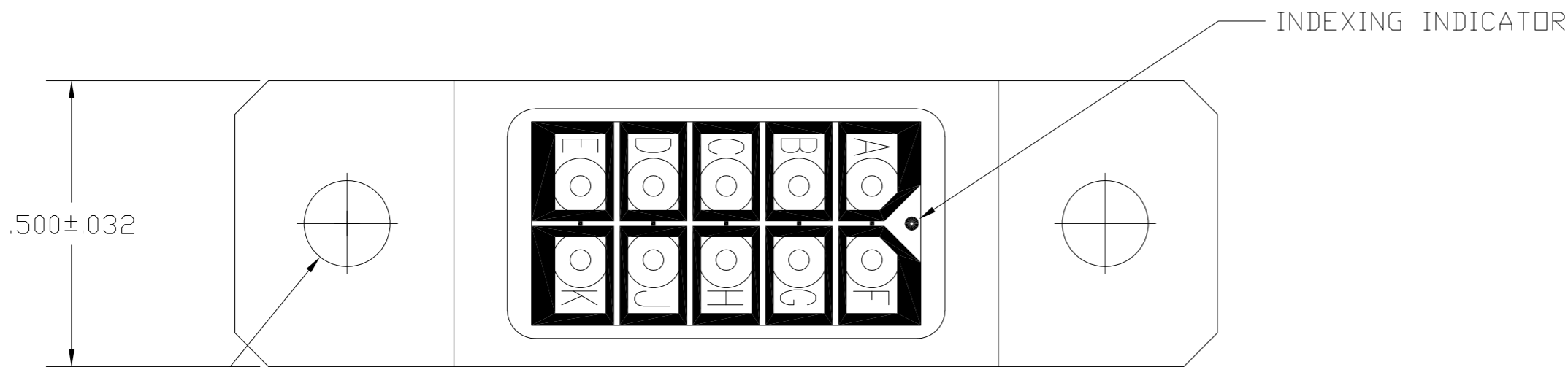
Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

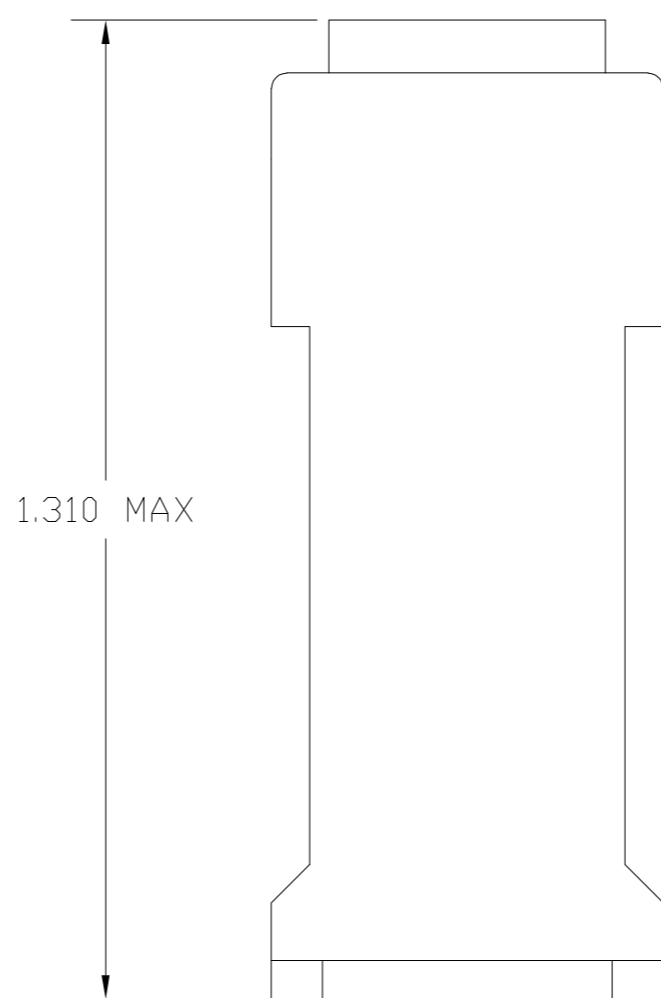
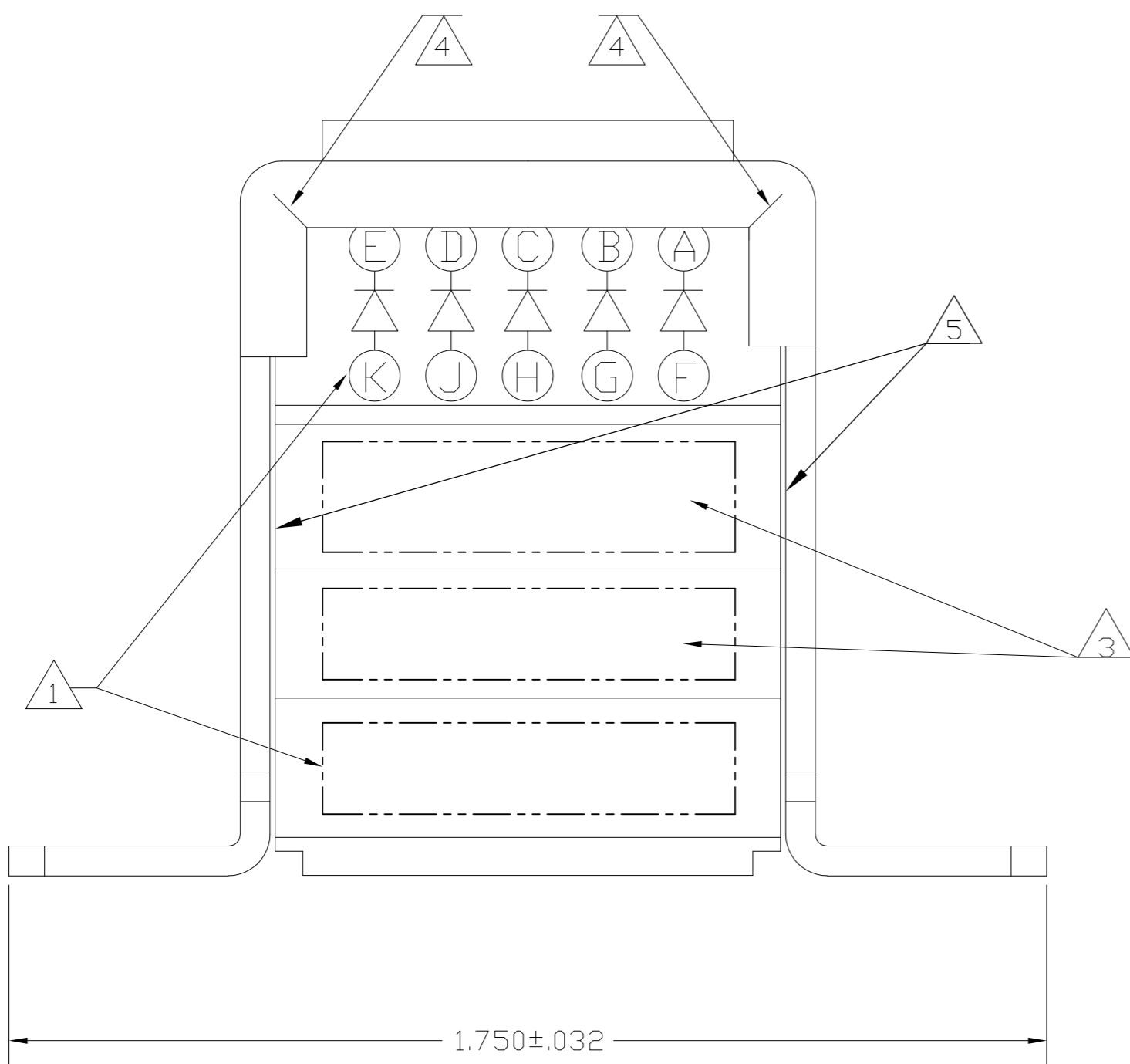


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LDC		DIST		REVISIONS			
P	LTR	DESCRIPTION	DATE	DWN	APVD		
DF	AO	F		REV PER ECD 08-000580	15JAN2009	PK	DE



∅.15
2 PLC



DESCRIPTION	MATERIAL	FINISH
GROMMET	FLUOROSILICONE RUBBER	COLOR: BLUE
MODULE ASSEMBLY	THERMOSET EPOXY	COLOR: BLACK
CONTACT, SOCKET ASSEMBLY	BERYLLIUM COPPER PER ASTM-B194	GOLD PLATE PER MIL-G-45204
CLIP CONTACT RETAINING	BERYLLIUM COPPER PER ASTM-B194 OR SST PER QQ-S-766	NONE
BRACKET	AL-ALLOY 6061-T4 (.050 THK)	NICKEL PLATE PER MIL-C-26074
DIODE	JANTXIN5618 ^{△6}	—
CONTACTS P/N M39029/1-101	COPPER ALLOY PER MIL-C-32029	GOLD PLATE PER MIL-G-45204
SEALING PLUGS	F.E.P. PER MIL-P-19468	COLOR: RED

- ^{△1} ASSEMBLIES ARE IDENTIFIED WITH "AMP", AMP P/N, DATE CODE, AND DIODE SCHEMATIC ON MODULE AT AREA SHOWN.
- ^{△2} CONTACTS AND SEALING PLUGS SUPPLIED WITH MODULE ASSEMBLY.
- ^{△3} MARK ASSEMBLY WITH CUSTOMER PART NO. 12079-20E-009 AT AREA SHOWN.
- ^{△4} CUTOUT IN CORNERS TO FACILITATE FORMING APPEARS AS AN OPENING BETWEEN THE BRACKET AND MODULE BLOCK.
- ^{△5} METAL MOUNTING BRACKET NOT BONDED TO MODULE ASSEMBLY.
- ^{△6} DIODE MQ1N5618, MX1N5618 OR MXV1N5618 MAY BE SUBSTITUTED FOR JAN1N5618 DIODES MAY BE A COMMERCIAL DIODE THAT HAS BEEN UP-SCREENED TO MEET THE REQUIREMENTS OF JAN1N5618

REMARKS	DESCRIPTION	PART NO
^{△2} ^{△3}	SIZE 20	591857-2
	SIZE 20	591857-1

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN J. MECK 7-27-92	Tyco Electronics Corporation Harrisburg, PA 17105-3608	
DIMENSIONS: INCHES		CHK R. RYAN 8-10-93	NAME -	
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APVD R. RYAN 8-10-93	PRODUCT SPEC -	
0 PLC ± -		APPLICATION SPEC -		
1 PLC ± -		WEIGHT -		
2 PLC ± .02		SCALE 4: 1		
3 PLC ± .005		SHEET 1 OF 1		
4 PLC ± -		REV F		
ANGLES ± -		CUSTOMER DRAWING		
FINISH		SIZE CAGE CODE DRAWING NO RESTRICTED TO		
SEE TABLE		A2 00779 C-591857		